

## APPLICATION DATA SHEET

Electronic Version v14  
 Stylesheet Version v14.0

|   |  |       |         |
|---|--|-------|---------|
| <b>Title of Invention</b>   | SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME UTILIZING PERMITTIVITY OF AN INSULATING LAYER TO PROVIDE A DESIRED CROSS CONDUCTIVE LAYER CAPACITANCE PROPERTY |       |         |
| Application Type: regular, utility<br>Attorney Docket Number: 32811US1        |  |       |         |
| Correspondence address:   |  |       |         |
| <b>Customer Number:</b>   |  | 00116 | *00116* |
| Continuing Data:  |  |       |         |
| This is a Continuation of US application number 09/616,086, filed 2000-07-14. |  |       |         |
| Priority Data:  |  |       |         |
| Doc.No: 11-200845; Country - JP; Date: 1999-07-14 us-priority-claimed         |  |       |         |
| Inventors Information:  |  |       |         |
| <u>Inventor 1:</u>  |  |       |         |
| <b>Applicant Authority Type:</b>  | Inventor   |       |         |
| <b>Citizenship:</b>   | JP   |       |         |
| <b>Name prefix:</b>   | Mr.  |       |         |
| <b>Given Name:</b>  | Masaki   |       |         |
| <b>Family Name:</b>   | Tamaru   |       |         |
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| <b>Country of Residence:</b>  | JP   |       |         |
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**Applicant Authority Type:** Inventor  
**Citizenship:** JP  
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**Assignee 1:**

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